

ACUROS[®] CQD[®] 1280L GigE eSWIR Camera

ACUROS-1280-GIGE-004

The ACUROS CQD L-Series extended SWIR (eSWIR) cameras feature large sensor area, low angular dependence and a long working distance for highly divergent emitters and collimated beams. ACUROS cameras deliver high resolution, high dynamic range and very high detectivity imaging from 400 nm to 2000 nm. The L-Series cameras are designed for use exclusively in laser beam diagnostics, laser beam imaging and laser alignment applications by mitigating interference fringing sources.

SPECIFICATIONS

Table 1. ELECTRO-OPTICAL SPECIFICATIONS

Parameter	Value/Description
Sensor	ACUROS CQD sensor
Temperature Stabilization	Single-stage thermo-electric cooler
Sensor Array Format	1280 x 1024
Resolution	1.31 MP (megapixel)
Spectral Band	400–2000 nm
Array Size	19.2 mm x 15.4 mm, 24.6 mm diagonal
Pixel Pitch	15 μm x 15 μm
Max Frame Rate at Full Resolution	88 fps (8 bit), 45 fps (10, 12, 14 bit)
Pixel Operability	99.9% typical, 99.75% min
Bit Depth	8, 10, 12, 14 bit selectable
Integration Type	Snapshot global shutter
Trigger	External TTL
Integration Time	100 μs to 4 s
Dynamic Range	65 dB typical
Windowing & Windowing Frame Rate	Array centered. Scales inversely to window size
Laser Beam Fringeless Operation	Yes
Binning Arrays	2 x 2, 4 x 4
Non-uniformity Correction	2-point non-uniformity correction
Temporal Dark Noise	80/70/65 e ⁻ typical
Quantum Efficiency	See typical QE curve (Figure 4)



ORDERING INFORMATION

Part Number
ACUROS-1280-GIGE-004

Features

- Large Sensor Size
- Short Working Distance for Highly Divergent Beams
- Low Angular Dependence
- Dynamic Range up to 70 dB
- Linear Photoresponse
- 1.2 MP Resolution
- TEC Cooling
- Low Noise
- GigE Vision
- Visible-eSWIR

Applications

- Laser beam Diagnostics
- Laser Beam Imaging
- Laser Alignment

Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

Parameter	Value/Description
Operating Case Temperature	-20 °C to +55 °C
Power Consumption	6.5–12 W depending on TEC settings
Power Supply Voltage	6–16 V dc. POE not supported
Regulatory Compliance	CE mark

Table 3. MECHANICAL SPECIFICATIONS

Parameter	Value/Description
Dimensions Excluding Lens	6.1 x 6.1 x 9.8 cm (C-mount)
Weight Excluding Lens	505 grams with (C-mount) adapter
Lens Mounts	Standard mount (C-mount). Inquire for other options.
Power Connector	Hirose 12-pin, HR10A-10R-12PB (71)
Trigger Connector	BNC

Table 4. SOFTWARE AND USER INTERFACE

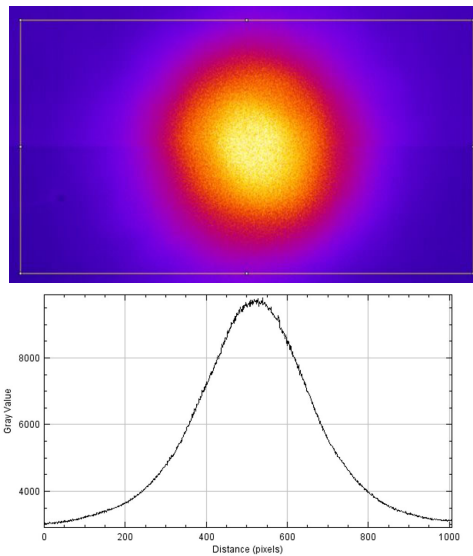
Parameter	Value/Description
Software Development Kit	Windows GUI
GenICam Compliance	Yes
Interface	GigE Vision



Figure 1. Lens Mount



Figure 2. GiGE Vision Interface



1550 nm Laser image and corresponding line file (false color added post image)

Figure 3. ACUROS CQD SWIR Camera Image of Laser

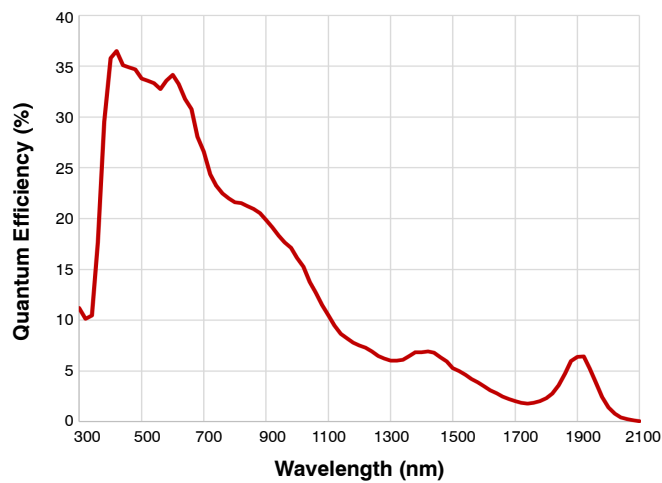


Figure 4. Typical QE Performance

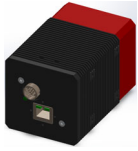
ACUROS-1280-GIGE-004

REVISION HISTORY

Revision	Description of Changes	Date
3	Removed "eBUS SDK" from Software Development Kit due to change in licensing.	3/13/2026

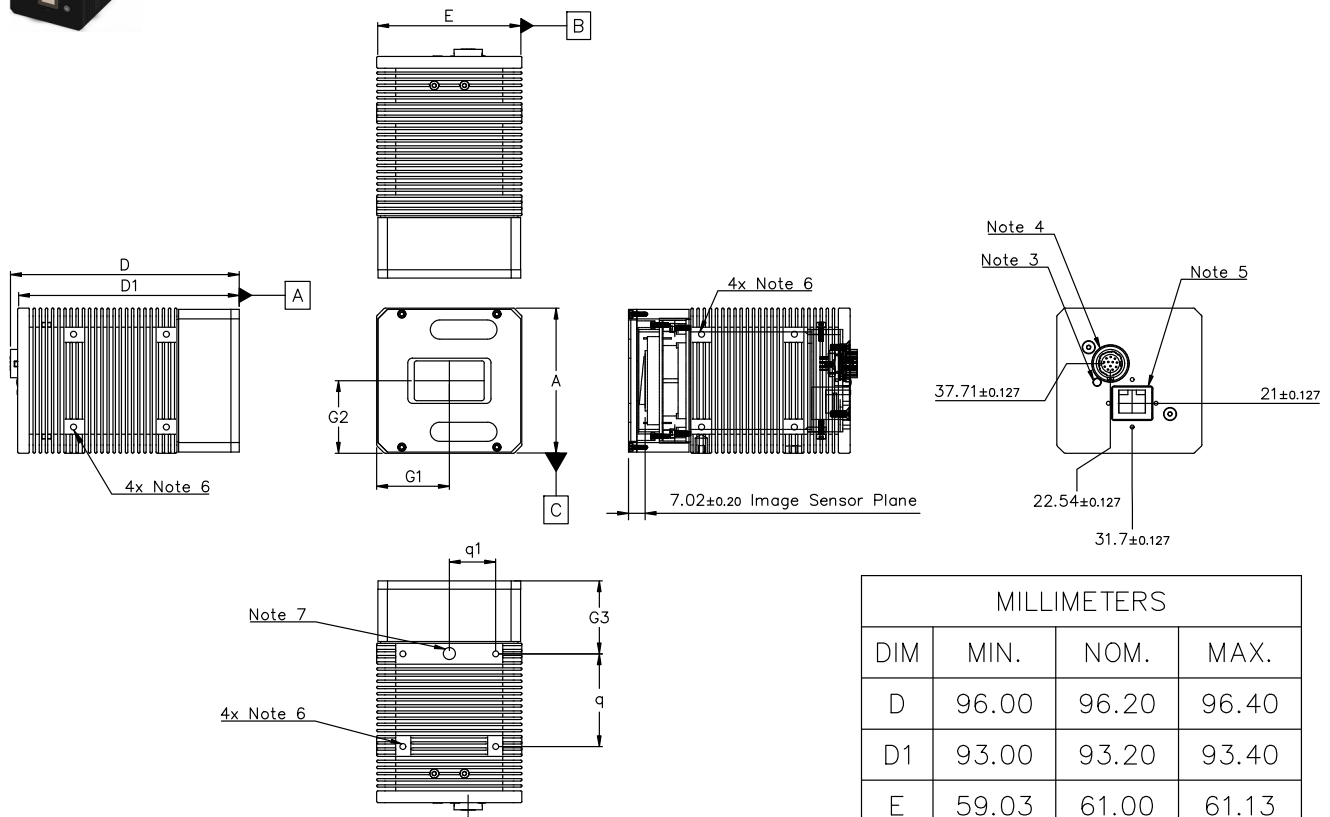
This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.





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CASE 810AD
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DATE 27 MAY 2025



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 2018.
2. CONTROLLING DIMENSION: MILLIMETER
3. POWER INIDCATOR
4. HIROSE 12 PIN CONNECTOR
5. GigE CONNECTOR
6. M3X0.5 DEPTH ∇ 3.0
7. 1/4-20 UNC DEPTH ∇ 5.08

MILLIMETERS			
DIM	MIN.	NOM.	MAX.
D	96.00	96.20	96.40
D1	93.00	93.20	93.40
E	59.03	61.00	61.13
A	59.03	61.00	61.13
G1	30.35	30.48	30.61
G2	30.35	30.48	30.61
G3	30.47	30.60	30.73
q	38.98	39.11	39.24
q1	19.37	19.50	19.63

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